Vishay Siliconix

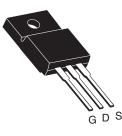
COMPLIANT

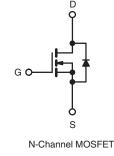


## Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	200			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.80		
Q <sub>g</sub> (Max.) (nC)	14			
Q <sub>gs</sub> (nC)	3.0			
Q <sub>gd</sub> (nC)	7.9			
Configuration	Single			

### **TO-220 FULLPAK**





### **FEATURES**

f = 60 Hz)

- Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; RoHS
- Sink to Lead Creepage Distance = 4.8 mm
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- · Lead (Pb)-free Available

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFI620GPbF
	SiHFI620G-E3
SnPb	IRFI620G
	SiHFI620G

ABSOLUTE MAXIMUM RATINGS T	<sub>C</sub> = 25 °C, ur	nless otherw	vise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	200	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	$V_{GS}$ at 10 V $T_{C}$ =	T <sub>C</sub> = 25 °C	1-	4.1		
		$T_C = 100 \ ^{\circ}C$	I <sub>D</sub>	2.6	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	16		
Linear Derating Factor				0.24	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub> 4.1		А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	3.0	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		PD	30	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	**	
Soldering Recommendations (Peak Temperature)	for 10 s		v	300 <sup>d</sup>	°C	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 8.9 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = 4.1 \text{ A}$  (see fig. 12).

c.  $I_{SD} \le 5.2$  A, dI/dt  $\le 95$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	ТҮР		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 65 - 4.1			ONT			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>				°C/W			
	- 1150							
<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ ,	unless otherv	vise noted						
PARAMETER	SYMBOL	TEST CONDITIONS		ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	ce to 25 °C,	I <sub>D</sub> = 1 mA	-	0.29	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 '	V	-	-	± 100	nA
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V		s = 0 V	-	-	25	<u> </u>
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 160 V	/, V <sub>GS</sub> = 0 V	= 0 V, T <sub>J</sub> = 125 °C -			250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 2.5 A <sup>b</sup>	-	-	0.80	Ω
Forward Transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> =	2.5 A <sup>b</sup>	1.5	-	-	S
Dynamic		•						<b></b>
Input Capacitance	Ciss	V <sub>GS</sub> = 0 V,			-	260	-	рF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0.V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	100	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	30	-		
Drain to Sink Capacitance	С		f = 1.0 MHz	2	-	12	-	
Total Gate Charge	Qg			-	-	14	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V} \qquad \begin{array}{c} I_D = 4.8 \text{ A}, \ V_{DS} = 160 \text{ V}, \\ \text{see fig. 6 and } 13^{\text{b}} \end{array}$		-	-		3.0
Gate-Drain Charge	Q <sub>gd</sub>				-	-		7.9
Turn-On Delay Time	t <sub>d(on)</sub>				-	7.2	-	
Rise Time	t <sub>r</sub>		= 100 V, I <sub>D</sub> =		-	22	-	1
Turn-Off Delay Time	t <sub>d(off)</sub>	$\begin{array}{c} R_{G} = 18\;\Omega,\;R_{D} = 20\;\Omega,\\ \text{see fig. 10}^{b} \end{array}$		-	19	-	ns	
Fall Time	t <sub>f</sub>			-	13	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	Ls			-	7.5	-		
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.1	A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	16		
Body Diode Voltage	$V_{SD}$	$T_J = 25 \ ^\circ C, \ I_S = 4.1 \ A, \ V_{GS} = 0 \ V^b$		-	-	1.8	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 4.8 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	150	300	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.91	1.8	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_E$						L_D)

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

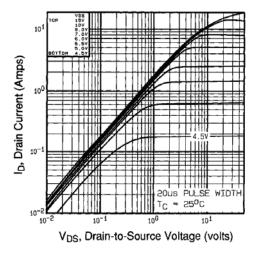


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

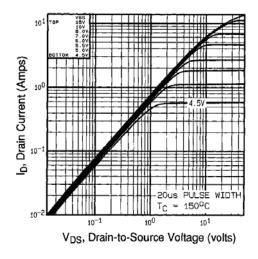


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150  $^\circ C$ 

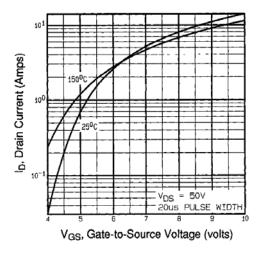


Fig. 3 - Typical Transfer Characteristics

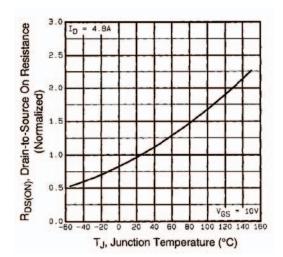


Fig. 4 - Normalized On-Resistance vs. Temperature

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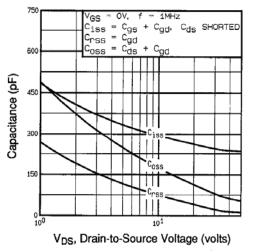


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

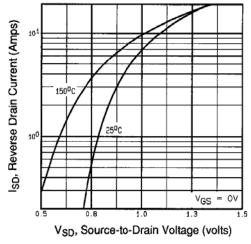


Fig. 7 - Typical Source-Drain Diode Forward Voltage

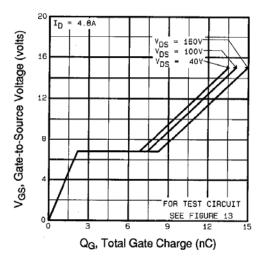


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

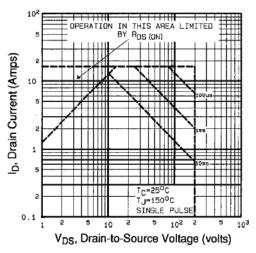


Fig. 8 - Maximum Safe Operating Area



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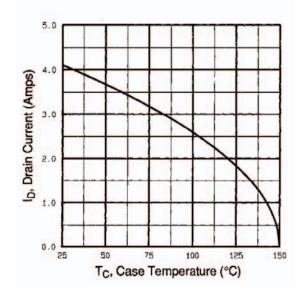


Fig. 9 - Maximum Drain Current vs. Case Temperature

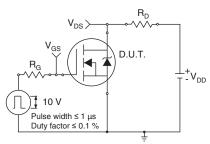


Fig. 10a - Switching Time Test Circuit

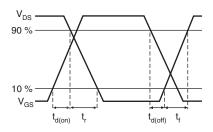
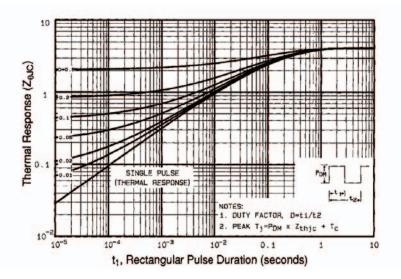
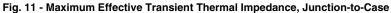


Fig. 10b - Switching Time Waveforms





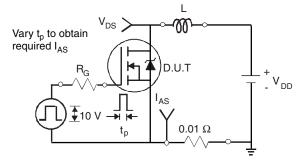


Fig. 12a - Unclamped Inductive Test Circuit

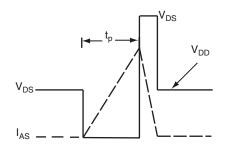


Fig. 12b - Unclamped Inductive Waveforms

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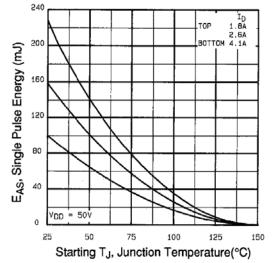


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

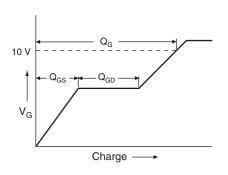
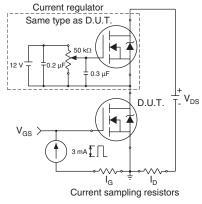


Fig. 13a - Basic Gate Charge Waveform

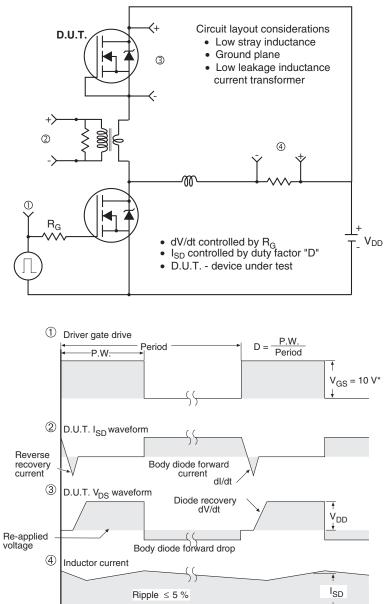






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Peak Diode Recovery dV/dt Test Circuit

\*  $V_{GS} = 5$  V for logic level and 3 V drive devices

Fig. 14 - For N-Channel

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